

## CBR08C908CCGAC

CBR-SMD RF COG, Ceramic, 0.9 pF, +/-0.25 pF, 500 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805

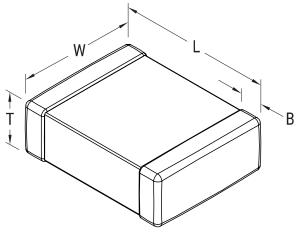
CBR-SMD RF COG

Low ESR, Class I

SMD, Fixed, RF, Ultra High Q,

Ultra High Q, Low ESR, Class I

SMD Chip



 RoHS
 Yes

 Termination
 Tin

 Marking
 No

 AEC-Q200
 No

 Typical Component Weight
 12.03 mg

 Notes
 Solder Wave or Solder Reflow.

 Shelf Life
 78 Weeks

**General Information** 

Series

Style Description

Features

MSL

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	0.85mm +/-0.1mm
В	0.5mm +/-0.2mm

Click here for the 3D model.

Specifications	
Capacitance	0.9 pF
Tolerance	+/-0.25 pF
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.239%
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	10 GOhms
Quality Factor	418

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Packaging Specifications

Packaging Packaging Quantity T&R, 180mm, Plastic Tape 4000

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